

M-Shaped Under-Bridge Feeding Method for a Low-Profile Dual-Band Dual-Polarized Antenna-on-Package in the 6G Upper Midband

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Abstract—A 2×4 dual-feed antenna-on-package (AoP) for 6G upper midband supports high power and dual-polarization, with a compact structure enabling potential use in smartphones and dense multiple-input-multiple-output (MIMO) base stations. The dual-feed antenna element is designed considering dual-linear polarization and dual-band operation. Consequently, the proposed antenna can provide dual-band, achieving a -6 dB impedance bandwidth of 32.3% (9.77 GHz to 13.45 GHz), port-to-port isolation higher than -15 dB, and the envelope correlation coefficient lesser than 0.02. The 2×4 antenna array for a MIMO antenna is fabricated for the evaluation of radiation characteristics. The proposed antennas are measured and verified by vertical probing system. Each element was measured with -6 dB impedance bandwidth of over 6.83% in low band and 4.9% in high band. The measured gain of boresight is achieved to 6.45 dBi at 10.25 GHz, and 6.7 dBi at 12.7 GHz, and the measured envelope correlation coefficients are all less than 0.04 in the dual-bandwidth.

Index Terms—6G upper midband, antenna-on-package (AoP), mobile antenna, multiple-input-multiple-output (MIMO) antenna.

I. INTRODUCTION

UPPER midband has recently emerged as a candidate frequency range for 6G mobile communication. With delays in the commercialization of 5G systems, there has been a shift toward lowering communication frequencies, allowing for more flexible use. The following new bands were proposed for wireless broadband use, 7.025 GHz to 7.125 GHz, 10 GHz to 10.5 GHz, and 12.7 GHz to 13.25 GHz (the upper 12 GHz band) [1], [2], [3]. Among these, 6G upper-mid technology is a promising candidate for implementing a high channel capacity, healthcare, and other applications. The coverage of upper midband could be less limited by increased oxygen absorption, path loss, and blockages, which is expected to improve coverage from the perspective of mobile devices. Antennas composed of

multiple layers, such as antenna-on-package (AoP), antenna-in-package (AiP), and antenna-in-display for 5G systems, have been developed with each layer thinner than $100 \mu\text{m}$ ($<0.01\lambda$ at 28 GHz) and advanced technologies to enhance line width resolution to support high-frequency operation at millimeter-wave and sub-THz bands [4], [5], [6], [7], [8], [9], [10], [11]. This has led to the development of extremely low-profile antennas around 1 mm of total thickness, and commercial mobile devices now demand 6G antennas with high radiation performance within the same thickness constraints [13], [14]. However, 6G AoP modules must support multiple-input-multiple-output (MIMO) systems to ensure reliable communication even within a compact form factor, and they are required to achieve dual polarization to enhance reception capacity performance [14]. MIMO antenna technologies for mobile devices were designed for a single band of 6.425 GHz to 8.4 GHz, which has particular challenges in achieving dual-bandwidth [13], [15]. Here, a novel M-shaped under-bridge (MUB) feeding structure is proposed for a dual-band, dual-linearly polarized compact patch antenna, targeting impedance-matching 6G MIMO AoP module applications. The AoP consists of multilayer printed circuit boards (PCBs) as in [5]; however, reduced thickness makes it difficult to maintain the reflection coefficient bandwidth in the upper midband. By adopting MUB indirect feeding, the proposed antenna overcomes bandwidth limitations and improves reflection coefficient and port isolation, which is further validated through thorough evaluation of the fabricated AoP module.

The rest of the letter is organized as follows. In Section II, the structure of the proposed AoP is described, and the principles of MUB feeding method are discussed in Section III. Section IV presents the verified results with measurements. Finally, Section V concludes this letter.

II. PROPOSED AOP DESIGN

A. 3-D Structure of the Proposed AoP Module

Fig. 1 illustrates the proposed AoP module for MIMO upper midband mobile applications. A 2×4 antenna array is proposed to consist of 16 ports, which is designed for each element to operate with two feeding ports to enable dual-polarization, as shown in Fig. 1(a). The single element of the proposed antenna consists of a circular patch resonating at the low band, and a ring patch segmented by four sectors designed to resonate together with it at the high band, as shown in Fig. 1(b). Subwavelength-sized dummy patterns were placed below the radiator to meet the copper balance requirement of the multilayer stack-up process.

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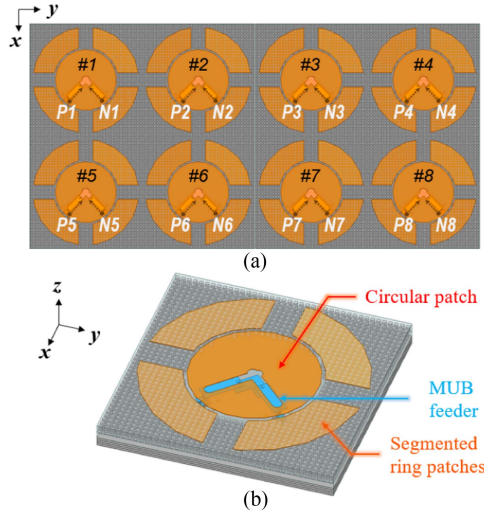


Fig. 1. Proposed AiP module for mobile applications. (a) Top view of the proposed 2×4 antenna array. (b) 3-D structure of a single element.

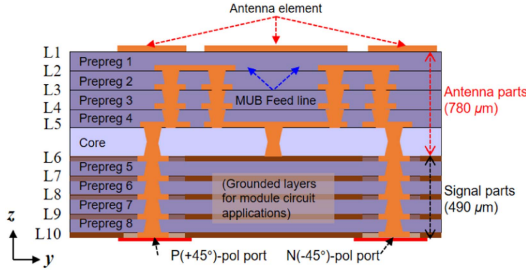


Fig. 2. Layer stack-up of the proposed AoP module: ten layers.

These patterns were strategically designed and arranged only around the circular resonant patch to minimize their impact on the resonant patch and the feeding structure.

B. Multilayer Structure of AoP

The antenna is mounted in a multilayer structure, as shown in Fig. 2, using substrates above the 300 μm -thick core (layer 3). The prepreg substrate has a permittivity value (ϵ_r) of 3.53, loss tangent ($\tan \delta$) value of 0.004, and a thickness of 100 μm . Each metal layer is composed of 18 μm . The practical antenna mounting space in a multilayer structure utilizes the substrates above the core (layers 1–5), with the core substrate (layer 3) having a thickness of 300 μm . Therefore, layer 6 serves as the main ground plane, and the substrates below are designed as circular ports for measurement purposes via drills. The proposed antenna is designed with this configuration to achieve dual-band operation within the upper midband bandwidth, satisfying the reflection coefficient criterion below -6 dB in the antenna section, while maintaining the ignorable loss of compact signal line in the signal section. It also offers a wide degree of design freedom and enables high antenna performance.

C. MUB Indirect Matching Structure

The MUB feeding structure proposed in this letter is designed to secure bandwidth for a dual-band patch antenna. This requires the prior design of a radiating element capable of dual resonance.

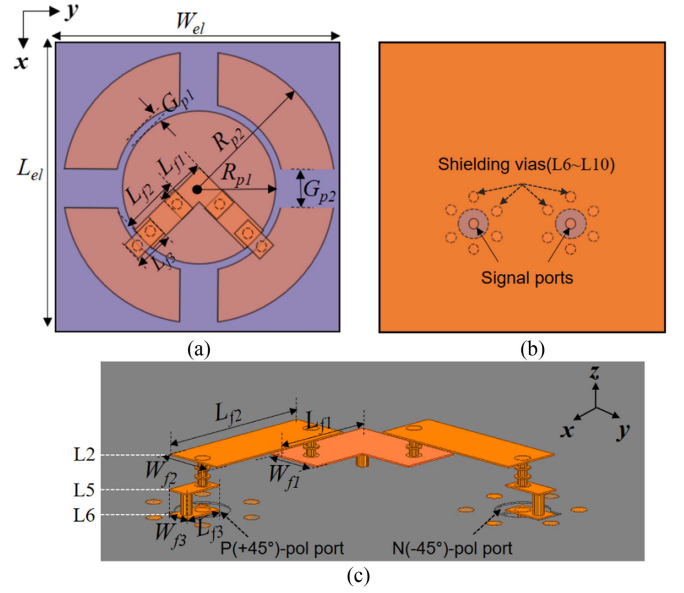


Fig. 3. (a) Top view. (b) Bottom view of proposed antenna. (c) Detailed description of the MUB feeding structure.

One effective method for achieving dual resonance in patch antennas involves surrounding the main patch with a parasitic patch. Fig. 3(a) shows the top view of the antenna, consisting of a circular patch with a surrounding ring patch divided into four sectors. The MUB structure enables slant polarization and wideband matching by connecting orthogonal P -port and N -port L-probes. The microstrip line on layer 5 (L5) is connected to each L-probe form through vias and is grounded through a central via. To support flip-chip type integration of the AoP module, the ground layer (L10) supports flip-chip integration with shielded cylindrical ports, as shown in Fig. 3(b). The MUB structure not only preserves strong coupling to the circular patch but also maximizes isolation between the P -port and N -port via the central bridge, as shown in Fig. 3(c). This is achieved by parametric study of the bridge design parameter L_{f1} , W_{f1} .

III. PRINCIPLE OF MUB DESIGN

The Z-parameters and S-parameters for the L-probe feeding structure are compared considering variations in the L_{f2} parameter, as shown in Fig. 4. According to Fig. 4(a), the radiating patch is capable of supporting dual-band radiation. However, as shown in Fig. 4(b), the mutual coupling between the two orthogonal feeding ports remains significant, resulting in a limited isolation level of approximately -12.4 dB. This level of interference poses a challenge in realizing effective port decoupling, thereby restricting the overall performance of the antenna system.

To address this limitation, the feeding structure is interpreted as a dual-resonant impedance-matching network comprising both series and parallel RLC elements. This model is intended to synthesize an impedance matching over two distinct frequency bands. The L-probe coupled-feeder can be equivalently represented by a series component. The L-probe coupled-feeder can be equivalently represented by a series component L_F (corresponding to the vertical via from the port) and parallel components L_P and C_P (representing the microstrip line section

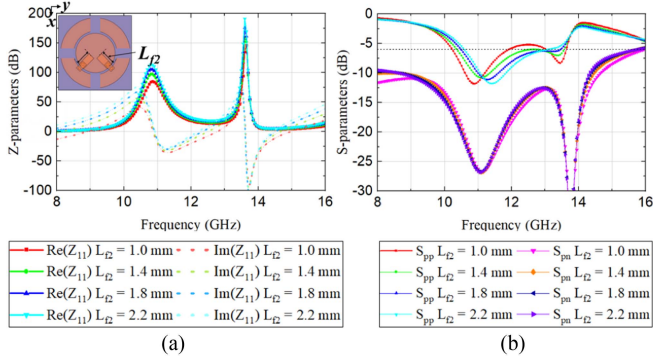


Fig. 4. Proposed antenna with L-probe feeding structure instead of MUB feeding structure. (a) Z-parameters along the variation of L_{f2} . (b) S-parameters along the variation of L_{f2} .

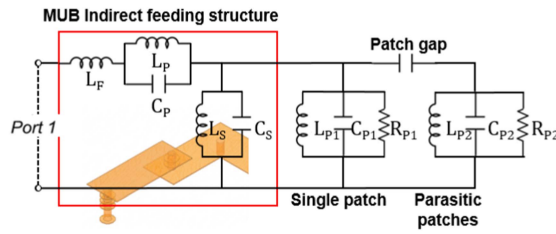


Fig. 5. Equivalent circuit model of MUB feeding structure. The component values are: $L_F = 0.64$ nH, $L_P = 0.28$ nH, $C_P = 1.04$ pF, $L_S = 0.64$ nH, and $C_S = 0.24$ pF.

TABLE I
OPTIMIZED DIMENSIONS OF THE SINGLE ANTENNA IN FIG. 3 (UNIT: MILLIMETER)

Parameter	Value	Parameter	Value
L_{el}	12.5 ($0.5 \lambda_0$)	W_{el}	12.5 ($0.5 \lambda_0$)
L_{f1}	0.8	W_{f1}	0.8
L_{f2}	2.2	W_{f2}	0.8
L_{f3}	0.58	W_{f3}	0.3
R_{p1}	3.4	G_{p1}	0.2
R_{p2}	5.9	G_{p2}	1.6

isolated from the radiating patch). However, the conventional L-probe feeder alone is insufficient in effectively suppressing the coupling between the orthogonally oriented ports. Therefore, the proposed MUB structure is introduced to incorporate a bridge layer that serves as an additional mechanism for enhancing port-to-port isolation. This bridge layer can be equivalently modeled using a shunt components L_S and C_S , which dominate the isolation behavior between the two resonant paths. Fig. 5 illustrates the equivalent circuit model of the proposed MUB feeding structure, which represents the coupling characteristics between the radiating patch and the MUB-based feeding mechanism.

The MUB feeding structure controls the isolation between the two ports while achieving reflection coefficients better than -6 dB across the operating band, corresponding to the widely adopted 3:1 VSWR criterion for mobile antennas. The design parameters of the proposed antenna are optimized in Table I. The optimized bandwidth is 9.77 GHz to 13.25 GHz in Fig. 6(a), and the isolation level is under -15 dB over the bandwidth in Fig. 6(b). Fig. 7 shows that the electric field is distributed on

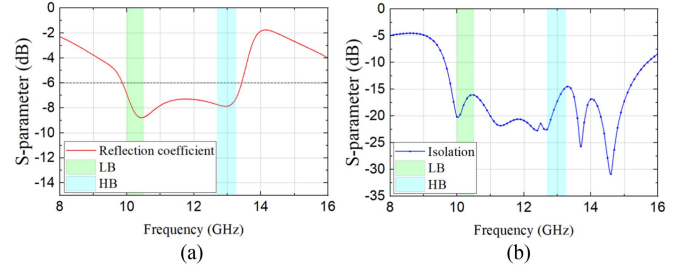


Fig. 6. (a) Reflection coefficient and (b) isolation of the proposed antenna with an optimized MUB feeding structure.

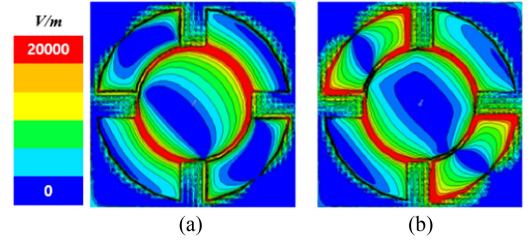


Fig. 7. Electric field distribution of the proposed antenna on the top layer when P-port is ON. (a) 10 GHz. (b) 12.7 GHz.

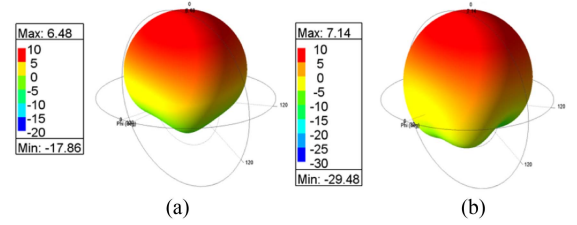


Fig. 8. 3-D far-field radiation pattern of realized gain when P-port is ON. (a) 10 GHz. (b) 12.7 GHz.

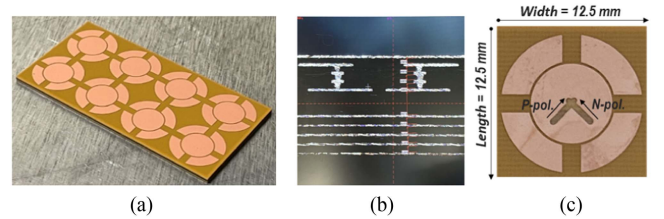


Fig. 9. (a) Fabricated 2×4 antenna array. (b) X-ray photograph of the side cross section of the fabricated sample. (c) Top view of the radiating patch with an added slot structure.

the main patch at 10 GHz, and is strongly distributed on the parasitic patches together at 12.7 GHz with when it is optimized with the MUB feeding structure. Fig. 8 shows the 3-D far-field radiation patterns of the proposed antenna for dual frequency, respectively.

IV. FABRICATION AND MEASUREMENT

Fig. 9(a) shows the fabricated sample of the proposed antenna. The thickness of the fabricated antenna is precisely measured through a cross-section cut, as shown in Fig. 9(b), revealing a

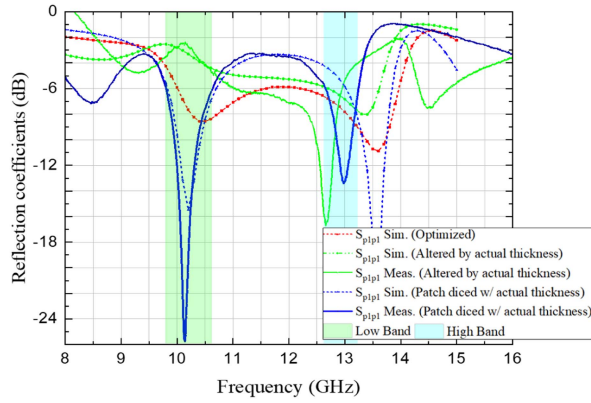
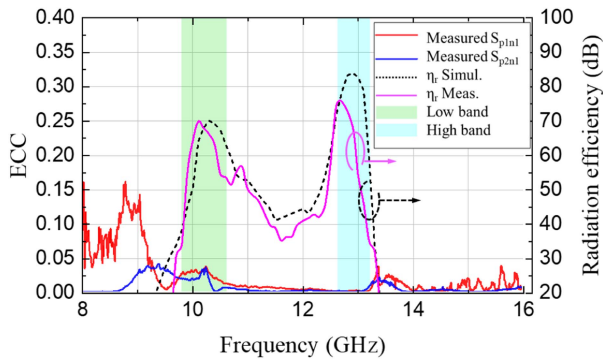
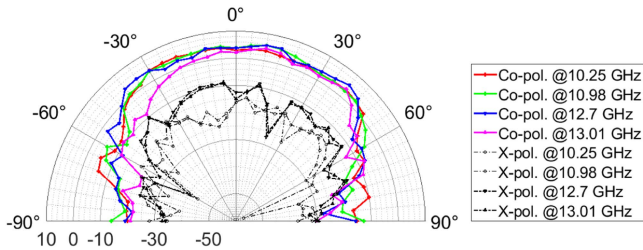


Fig. 10. Compared reflection coefficients of the fabricated samples.

Fig. 11. ECC and radiation efficiency of a single antenna element along frequency, based on measured S_{p1N1} , S_{p2N1} , and simulated/measured efficiency.Fig. 12. Far-field radiation patterns of the realized gain at $+45^\circ$ plane, when P1-port of the proposed antenna is ON.

change in the thickness of the antenna substrate. Upper substrate of the antenna part became thinner by $12.5 \mu\text{m}$ each. Consequently, the spacing between the metal layers (L1 and L2) is significantly influenced by the coupling between the feed structure and the radiating patches.

The fabricated sample was measured using a vertically mountable measurement setup with a vector network analyzer and $650 \mu\text{m}$ -pitch ground-signal-ground (GSG) probes. Calibration and measurement of the modules were carried out on a RO-HACELL foam. The bandwidth of the fabricated sample was altered due to changes in the actual thickness. The thickness of each substrate layer is measured using the cross section of the X-ray image, as shown in Fig. 9(b). The measured reflection coefficients are analyzed by comparing the modified substrate thickness into the simulation, as presented in Fig. 10. It is presumed that the substrate thickness variation influenced the coupling (L_P and C_P) of the MUB feeding structure, as illustrated

TABLE II
COMPARISON OF STATE-OF-ART MIMO ANTENNAS

Ref.	Bandwidth	Arrays	Number of Ports	Size ($W \times L \times t$)**	ECC
[5]	26–31, 37–40	1×4	8	$0.49\lambda_0 \times 0.49\lambda_0 \times 0.089\lambda_0$	N.A.
[12]	7.025–8.4*	2×2	16	$0.8\lambda_0 \times 0.8\lambda_0 \times 0.026\lambda_0$	< 0.05
[13]	7.025–8.4*	2×2	16	$0.5\lambda_0 \times 0.5\lambda_0 \times 0.026\lambda_0$	< 0.005
[14]	6.4–8.6	1×2	8	$0.59\lambda_0 \times 0.59\lambda_0 \times 0.025\lambda_0$	< 0.02
This work	9.81–10.63, 12.65–13.24*	2×4	16	$0.5\lambda_0 \times 0.5\lambda_0 \times 0.029\lambda_0$	< 0.03

* The -6 dB matching criterion is commonly adopted for evaluating the effectiveness of mobile antennas. ** The size is based on a single element.

by the equivalent circuit in Fig. 5. Slot structures are added to the resonant patch to modify the coupling between the resonant patch and the MUB feeding structure, as shown in Fig. 9(c). This slot is a defected structure designed along the direction parallel to the MUB feeding line within the patch pattern, with dimensions of $3.1 \text{ mm} \times 0.53 \text{ mm}$. Finally, the measured results of the modified sample closely resemble the simulation results, with the measured reflection coefficient bandwidth under -6 dB to be 9.81 GHz to 10.63 GHz and 12.65 GHz to 13.24 GHz, as shown in Fig. 10, which corresponds to the simulation results. The envelope correlation coefficient (ECC) measurement results were obtained by calculating far-field radiation patterns of a single element. As shown in Fig. 11, for the dual-bandwidth operation, the ECC values remain below 0.03, confirming the uncorrelated nature between the ports. The proposed antenna exhibits broad radiation characteristics with realized gains of 6.45 dBi and 6.7 dBi, and radiation efficiencies of 85.9% and 89.14% at 10.25 GHz and 12.7 GHz, respectively. The far-field radiation pattern of the proposed antenna is measured, as shown in Fig. 12.

V. CONCLUSION

A novel dual-feed AoP module has been proposed for 6G upper midband applications, featuring dual-linear polarization and dual-band operation within a compact multilayer PCB. The introduction of an MUB feeding structure is a key innovation, enabling improved impedance matching and wideband performance while maintaining a low-profile and space-efficient design. The fabricated 2×4 AoP array achieves impedance bandwidths of -6 dB of 9.81 GHz to 10.63 GHz and 12.65 GHz to 13.24 GHz, with ECC values below 0.03 across both bands, indicating proper isolation. The proposed antenna is compared with other state-of-the-art MIMO antennas in Table II, and its achievement of dual-band and dual-polarization operation is highlighted. These findings demonstrate that the proposed MUB-enabled AoP architecture offers strong potential for integration into high performance and space-constrained MIMO systems in next-generation mobile devices.

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